

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

Features

- DESIGNED FOR HIGH POWER PULSED IFF, DME, AND TACAN APPLICATIONS
- 350 W (typ.) IFF 1030 1090 MHz
- 300 W (min.) DME 1025 1150 MHz
- 290 W (typ.) TACAN 960 1215 MHz
- 960 1215 MHz
- GOLD METALLIZATION
- **P**_{OUT} = 300W MINIMUM
- $G_P = 6.3 \text{ dB MINIMUM}$
- INFINITE VSWR CAPABILITY @ RATED CONDITIONS
- EMITTER BALLASTED
- COMMON BASE

DESCRIPTION:

The MS2421 is a gold metallized silicon, NPN power transistor designed for applications requiring high peak power and low duty cycles such as IFF, DME, and TACAN. The MS2421 is designed with internal input/output matching resulting in improved broadband performance and low thermal resistance.

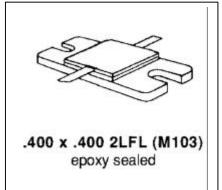
ABSOLUTE MAXIMUM RATINGS (Tcase = 25°C)

Symbol	Parameter	Value	Unit	
P _{DISS}	Power Dissipation	875	W	
V _{CES}	Collector-Emitter Voltage	65	V	
V _{CBO}	Collector-Base Voltage	65	V	
V _{EBO}	Emitter-Base Voltage	3.5	V	
TJ	Junction Temperature	200	⁰ C	
Ι _c	Device Current	22	Α	
Т _{stg}	Storage Temperature	-65 to +200	^⁰ C	

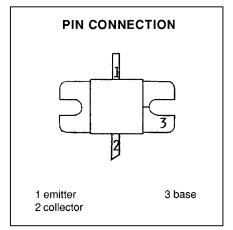
Thermal Data

R _{TH(J-C)} Junction-case Thermal Resistance	0.20	°C/W
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MS2421





MS2421

ELECTRICAL SPECIFICATIONS (Tcase = 25° C)

STATIC

Symbol	Test Conditions		Value	Unit			
Symbol	Test conditions		Mir	n. Typ.	Max.	Unit	
BV _{CBO}	l _c = 10 mA	l _E = 0 mA	65			v	
BV _{EBO}	l _E = 5.0 mA	I _C = 0 mA	3.5			v	
I _{CES}	V _{CE} = 50 V				25	mA	
HFE	$V_{CE} = 5 V$	I _C = 500mA	10		200	mA	

DYNAMIC

Symbol	Test Conditions				Unit		
Symbol Test Conditions				Min.	Тур.	Max.	Unit
Ρουτ	f =1025 - 1150 MHz	P _{IN} = 70W	V _{CE} =50V	300			W
G₽	f =1025 - 1150 MHz	P _{IN} = 70W	V _{CE} =50V	6.3			dB
ης	f =1025 - 1150 MHz	P _{IN} = 70W	V _{CE} =50V	35			%
Conditions	Pulse Width = 10 μ s	Duty Cycle =	1%				

IMPEDANCE DATA

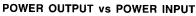
FREQ	$Z_{IN}(\Omega)$	$Z_{CL}(\Omega)$
960 MHz	2.6 + j6.0	2.5 – j6.0
1090 MHz	7.4 + j4.4	2.4 – j6.2
1215 MHz	4.3 + j1.1	2.5 – j4.9

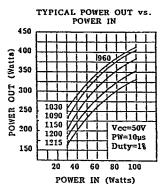
Pin = 70W Vce = 50V



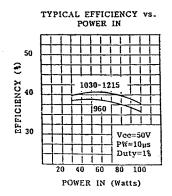
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TYPICAL PERFORMANCE

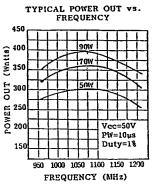




EFFICIENCY vs POWER INPUT

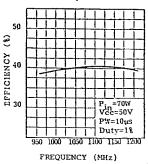


POWER OUTPUT vs FREQUENCY

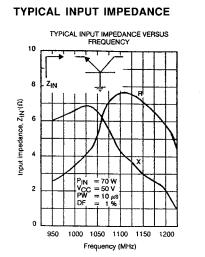


EFFICIENCY vs FREQUENCY

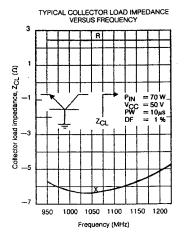
TYPICAL EFFICIENCY vs. FREQUENCY

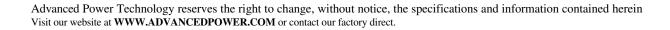


IMPEDANCE DATA



TYPICAL COLLECTOR LOAD IMPEDANCE

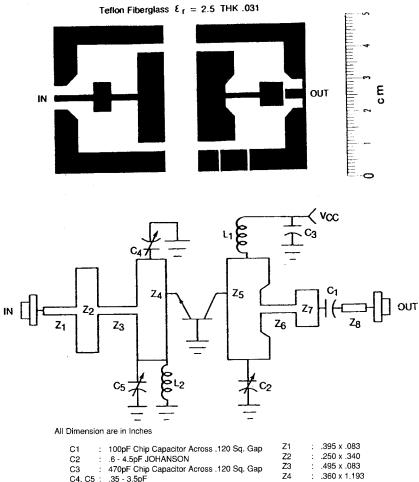






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TEST CIRCUIT



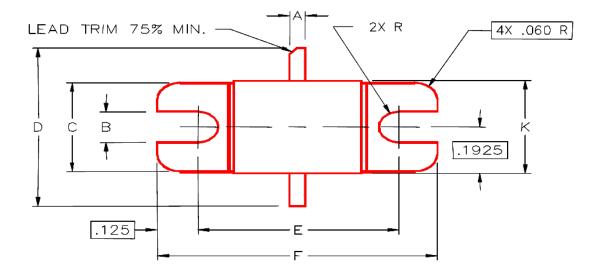
	.35 - 3.5pF	Z4	:	.360 x 1.193
• 1, •• 1	ing and	Z5	:	.485 x 1.2
11 :	2 3/4 Turns Diameter 16 Tinned .125 I.D.	Z6	:	.520 x .035
	.215 Long	Z7	:	.270 x .330
L2 :	2 3/4 Turns Diameter 20 Tinned .090 I.D. .220 Long	Z8	:	.270 x .110



MS2421

PACKAGE MECHANICAL DATA

PACKAGE STYLE M103





	MINIMUM	MAXIMUM	Π		MINIMUM	MAXIMUM
	INCHES/MM	INCHES/MM			INCHES/MM	INCHES/MM
А	.045/1,14	.055/1,40		1	.110/2,79	.130/3,30
В	.130/	/3,30		J	.190/4,83	.215/5,46
С	.380/9,65	.390/9,91		К	.390/9,91	.410/10,41
D	.880/22,35	.920/23,37				
E	.645/16,38	.655/16,64				
F	.890/22,61	.910/23,11	Π			
G	.002/0,05	.006/0,15				
Н	.055/1,40	.065/1,65				